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浙江宇力微新能源科技有限公司



V 1.1

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High Current IO+/- 2A/2.5A HALF-BRIDGE DRIVER

General Description

The U2104(S/M) is high voltage, high speed power MOSFET and IGBT driver with dependent high and low side referenced output channels. Proprie- tary **HVIC** and latch immune CMOS technologies enable ruggedizedmonolithic construction. The logic input is compatible with standard CMOS or LSTTL output. down to 3.3V logic. The output drivers feature a high pulse current buffer stage designed for minimum driver crossconduction. The floating channel can be used to drive an N-channel power MOSFET or IGBT in the high side configuration which operates up to 600 volts.

Product Summary

VOFFSET	600V max
IO+/-	2A / 2.5A
VCCton/off (typ.)	8.9V & 8.2V
Deadtime (typ.)	520 ns
Work Tem	-40 ~150 °C

Products Information

Key Features

- Floating channel designed for bootstrap operation
- Fully operational to +600V
- Tolerant to negative transient voltage dV/dt immune
- Gate drive supply range from 8 to 20V
- Undervoltage lockout
- 3.3V, 5V and 15V input logic compatible
- Cross-conduction prevention logic
- internally set deadtime
- High side output in phase with input
- shut down input turns off both channels
- Matched propagation delay for both channels

Applications

- Home appliances
- Industrial applications and drives
- Motor drivers
- DC, AC, PMDC and PMAC motors
- Induction heating
- HVAC

Packages



Base Part	Backago Typo	Standard OUT		VOFFSET	Logic	
Number	Package Type IO+ IO-		10-	VOFFSET	Control	
U2104	SOP8	2A	2.5A	600V	IN & SD	
U2104S	SOP8	1.2A	1.5A	600V	IN & SD	
U2104M	SOP8	0.4A	0.6A	600V	IN & SD	



Pin Assignments



Pin Function

Number	Symbol	Description
1	VCC	Low side and logic fixed supply
2	IN	Logic input for high and low side gate driver outputs (HO and LO)
3	SD	Logic input for shutdown
4	COM	Low side return
5	LO	Low side gate drive output
6	VS	High side floating supply return
7	НО	High side gate drive output
8	VB	High side floating supply

Typical Application



Part	Typical value	
D1	BYV26B	
C1	10uF/25V	
C2	0.1uF/63V	
R1	20R	
R2	20R	
Q1	IRF830	
Q2	IRF830	



Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition	Min.	Max.	Units
VB	High side floating absolute voltage	-0.3	625	
VS	High side floating supply offset voltage	VB - 25	VB + 0.3	
VHO	High side floating output voltage	VS - 0.3	VB + 0.3	v
VCC	Low side and logic fixed supply voltage	-0.3	25	
VLO	Low side output voltage	-0.3	VCC + 0.3	
VIN	Logic input voltage (IN & SD)	-0.3	VCC + 0.3	
dVs/dt	Allowable offset supply voltage transient	_	50	V/ns
PD	Package power dissipation @ TA ≤ +25°C (8 lead SOIC)	_	0.625	W
RthJA	Thermal resistance, junction to ambient (8 lead SOIC)	_	200	°C/W
TJ	Junction temperature	—	150	
TS	Storage temperature	-55	150	°C
TL	Lead temperature (soldering, 10 seconds)		300	

Recommended Operating Conditions

The Input/Output logic timing diagram is shown in Figure 1. For proper operation the device should be used within the recommended conditions. The VS offset rating is tested with all supplies biased at 15V differential.

Symbol	Definition	Min.	Max.	Units
VB	High side floating supply absolute voltage	VS + 10	VS + 20	
VS	High side floating supply offset voltage	-0.3	600	V
VHO	High side floating output voltage	VS	VB	
VCC	Low side and logic fixed supply voltage	8	20	V
VLO	Low side output voltage	0	VCC	V
VIN	Logic input voltage (HIN&LIN)	0	VCC	V
ТА	Ambient temperature	-40	125	°C

1.版本记录

DATE	REV.	DESCRIPTION
2018/04/19	1.0	First Release
2010/05/21	1.1	Change the package

2.免责声明

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